

Description

The VST25N140 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

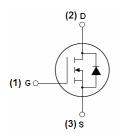
- $V_{DS} = 250V, I_{D} = 90A$ $R_{DS(ON)} < 15m\Omega @ V_{GS} = 10V$
- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- Optimized body diode reverse recovery performance

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



TO-263



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST25N140-T3	VST25N140	TO-263	Ø330mm	21mm	800 units

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	250	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	I _D	90	Α	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	63.6	Α	
Pulsed Drain Current	I _{DM}	360	Α	
Maximum Power Dissipation	P _D	330	W	
Derating factor		2.2	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	1700	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C	



Thermal Characteristic

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	BV _{DSS} V _{GS} =0V I _D =250μA			-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =250V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5		4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =45A	-	14	15	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =45A	70	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	\/ -405\/\/ -0\/	-	6595	-	PF
Output Capacitance	Coss	V_{DS} =125V, V_{GS} =0V, F=1.0MHz	-	409.5	-	PF
Reverse Transfer Capacitance	C _{rss}	r-1.0lvinz	-	11	-	PF
Switching Characteristics (Note 4)	·		•			
Turn-on Delay Time	t _{d(on)}		-	19.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =125 V , I_{D} =45 A	-	28	-	nS
Turn-Off Delay Time	t _{d(off)}	$V_{GS}\text{=}10V,R_{G}\text{=}4.7\Omega$	-	48	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	\/ -405\/ -450	-	90.9		nC
Gate-Source Charge	Q _{gs}	V_{DS} =125V, I_{D} =45A, V_{GS} =10V	-	40.4		nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V	-	18		nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =90A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	90	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 45A	-	186		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	1.35		uC

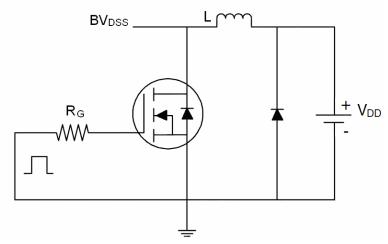
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\!\!\mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

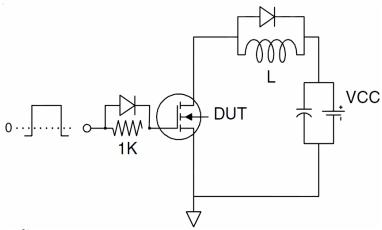


Test Circuit

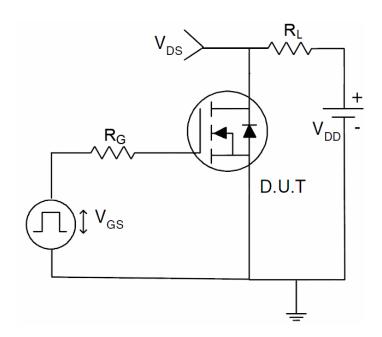
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







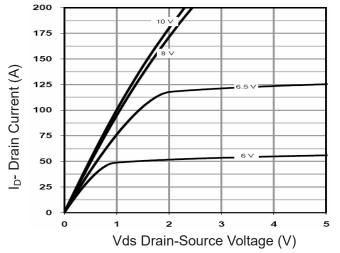


Figure 1 Output Characteristics

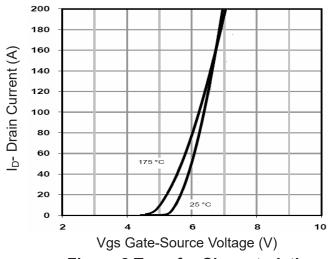
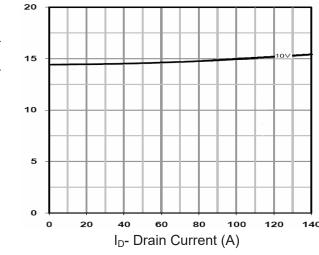


Figure 2 Transfer Characteristics



Rdson On-Resistance(m 2)

Figure 3 Rdson- Drain Current

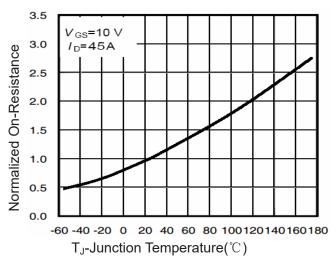


Figure 4 Rdson-JunctionTemperature

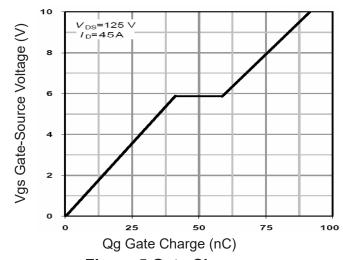


Figure 5 Gate Charge

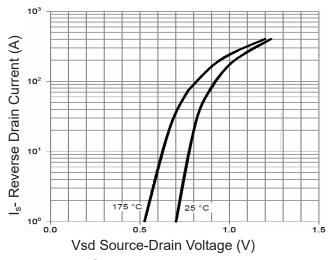


Figure 6 Source- Drain Diode Forward



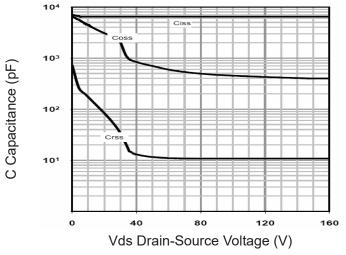
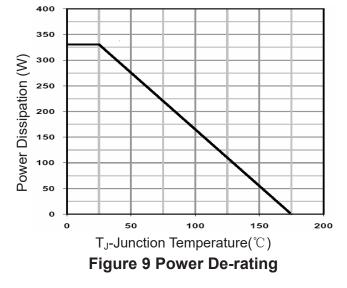


Figure 7 Capacitance vs Vds



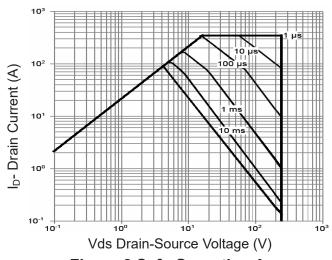


Figure 8 Safe Operation Area

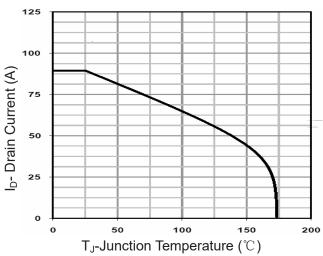


Figure 10 Current De-rating

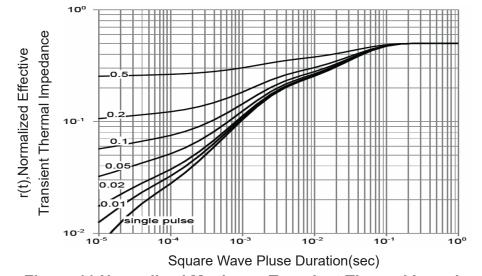


Figure 11 Normalized Maximum Transient Thermal Impedance